

## Product Summary

| BV <sub>DSS</sub> | R <sub>DS(ON)</sub> Max       | I <sub>D</sub> Max<br>T <sub>C</sub> = +25°C |
|-------------------|-------------------------------|----------------------------------------------|
| 100V              | 32mΩ @ V <sub>GS</sub> = 10V  | 24A                                          |
|                   | 50mΩ @ V <sub>GS</sub> = 4.5V | 19A                                          |

## Description and Applications

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

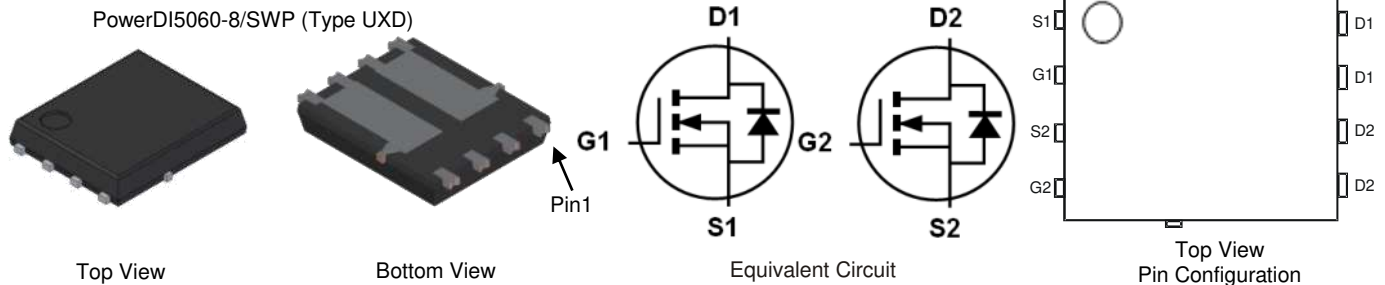
- DC-DC converters
- Motors

## Features and Benefits

- Rated to +175°C – Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production – Ensures More Reliable and Robust End Application
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Additional Tin-plated on Sidewall Pads for Optical Solder Inspection
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com/quality/product-definitions/) or your local Diodes representative.**

## Mechanical Data

- Package: PowerDI<sup>®</sup>5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Weight: 0.097 grams (Approximate)

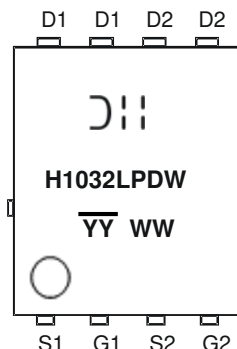


## Ordering Information (Note 4)

| Part Number       | Package                      | Packing |             |
|-------------------|------------------------------|---------|-------------|
|                   |                              | Qty.    | Carrier     |
| DMTH10H032LPDW-13 | PowerDI5060-8/SWP (Type UXD) | 2500    | Tape & Reel |

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



☐ = Manufacturer's Marking  
 H1032LPDW = Product Type Marking Code  
 YYWW = Date Code Marking  
 YY = Year (ex: 22 = 2022)  
 WW = Week (01 to 53)

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                                                          | Symbol           | Value    | Unit |
|-----------------------------------------------------------------------------------------|------------------|----------|------|
| Drain-Source Voltage                                                                    | V <sub>DSS</sub> | 100      | V    |
| Gate-Source Voltage                                                                     | V <sub>GSS</sub> | ±20      | V    |
| Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6)                                | I <sub>D</sub>   | 24<br>17 | A    |
| Maximum Body Diode Forward Current                                                      | I <sub>S</sub>   | 24       | A    |
| Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)                                      | I <sub>DM</sub>  | 96       | A    |
| Pulsed Body Diode Forward Current (10μs Pulse, T <sub>C</sub> = +25°C, Package Limited) | I <sub>SM</sub>  | 96       | A    |
| Avalanche Current, L = 0.3mH                                                            | I <sub>AS</sub>  | 13       | A    |
| Avalanche Energy, L = 0.3mH                                                             | E <sub>AS</sub>  | 25.3     | mJ   |

**Thermal Characteristics**

| Characteristic                                   | Symbol                            | Value       | Unit |
|--------------------------------------------------|-----------------------------------|-------------|------|
| Thermal Resistance, Junction to Ambient (Note 5) | R <sub>θJA</sub>                  | 50          | °C/W |
| Total Power Dissipation                          | P <sub>D</sub>                    | 3           | W    |
| Thermal Resistance, Junction to Case (Note 6)    | R <sub>θJC</sub>                  | 3.8         | °C/W |
| Total Power Dissipation                          | P <sub>D</sub>                    | 37          | W    |
| Operating and Storage Temperature Range          | T <sub>J</sub> , T <sub>STG</sub> | -55 to +175 | °C   |

**Electrical Characteristics Q1 N-Channel** (@T<sub>C</sub> = +25°C, unless otherwise specified.)

| Characteristic                             | Symbol              | Min | Typ  | Max  | Unit | Test Condition                                                                              |
|--------------------------------------------|---------------------|-----|------|------|------|---------------------------------------------------------------------------------------------|
| <b>OFF CHARACTERISTICS (Note 7)</b>        |                     |     |      |      |      |                                                                                             |
| Drain-Source Breakdown Voltage             | BV <sub>DSS</sub>   | 100 | —    | —    | V    | V <sub>GS</sub> = 0V, I <sub>D</sub> = 1mA                                                  |
| Zero Gate Voltage Drain Current            | I <sub>DSS</sub>    | —   | —    | 1    | μA   | V <sub>DS</sub> = 80V, V <sub>GS</sub> = 0V                                                 |
| Gate-Source Leakage                        | I <sub>GSS</sub>    | —   | —    | ±100 | nA   | V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V                                                |
| <b>ON CHARACTERISTICS (Note 7)</b>         |                     |     |      |      |      |                                                                                             |
| Gate Threshold Voltage                     | V <sub>GS(TH)</sub> | 1.3 | —    | 2.5  | V    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA                                  |
| Static Drain-Source On-Resistance          | R <sub>DS(ON)</sub> | —   | 24   | 32   | mΩ   | V <sub>GS</sub> = 10V, I <sub>D</sub> = 5A                                                  |
|                                            |                     | —   | 34   | 50   |      | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 4.5A                                               |
| Diode Forward Voltage                      | V <sub>SD</sub>     | —   | 0.8  | 1    | V    | V <sub>GS</sub> = 0V, I <sub>S</sub> = 5A                                                   |
| <b>DYNAMIC CHARACTERISTICS (Note 8)</b>    |                     |     |      |      |      |                                                                                             |
| Input Capacitance                          | C <sub>iss</sub>    | —   | 683  | —    | pF   | V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0V,<br>f = 1MHz                                    |
| Output Capacitance                         | C <sub>oss</sub>    | —   | 165  | —    | pF   |                                                                                             |
| Reverse Transfer Capacitance               | C <sub>rss</sub>    | —   | 6.9  | —    | pF   |                                                                                             |
| Gate Resistance                            | R <sub>g</sub>      | —   | 1.2  | —    | Ω    | V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1MHz                                        |
| Total Gate Charge (V <sub>GS</sub> = 4.5V) | Q <sub>g</sub>      | —   | 6.3  | —    | nC   | V <sub>DS</sub> = 50V, I <sub>D</sub> = 6A                                                  |
| Total Gate Charge (V <sub>GS</sub> = 10V)  | Q <sub>g</sub>      | —   | 11.9 | —    | nC   |                                                                                             |
| Gate-Source Charge                         | Q <sub>gs</sub>     | —   | 2.0  | —    | nC   |                                                                                             |
| Gate-Drain Charge                          | Q <sub>gd</sub>     | —   | 3.1  | —    | nC   |                                                                                             |
| Turn-On Delay Time                         | t <sub>D(ON)</sub>  | —   | 4.1  | —    | ns   | V <sub>DS</sub> = 50V, R <sub>L</sub> = 5.85Ω<br>V <sub>GS</sub> = 10V, R <sub>g</sub> = 3Ω |
| Turn-On Rise Time                          | t <sub>r</sub>      | —   | 4.5  | —    | ns   |                                                                                             |
| Turn-Off Delay Time                        | t <sub>D(OFF)</sub> | —   | 12.5 | —    | ns   |                                                                                             |
| Turn-Off Fall Time                         | t <sub>f</sub>      | —   | 9.3  | —    | ns   | I <sub>F</sub> = 6A, di/dt = 500A/μs                                                        |
| Reverse Recovery Time                      | t <sub>RR</sub>     | —   | 31.5 | —    | ns   |                                                                                             |
| Reverse Recovery Charge                    | Q <sub>RR</sub>     | —   | 94.6 | —    | nC   |                                                                                             |

- Notes:
- Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
  - Thermal resistance from junction to solder point (on the exposed drain pin).
  - Short duration pulse test used to minimize self-heating effect.
  - Guaranteed by design. Not subject to product testing.

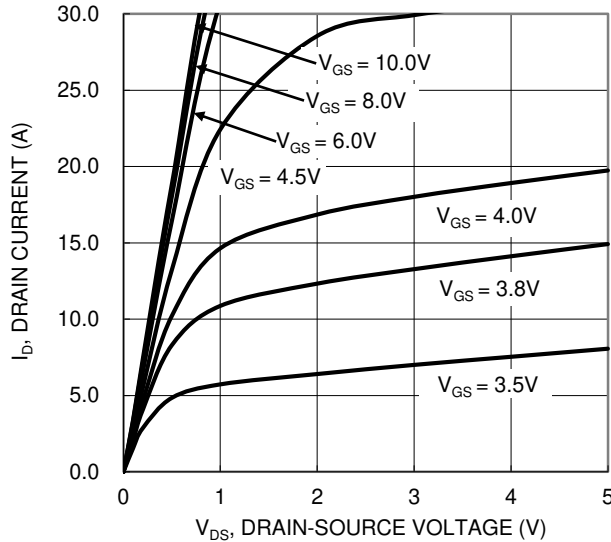


Figure 1. Typical Output Characteristic

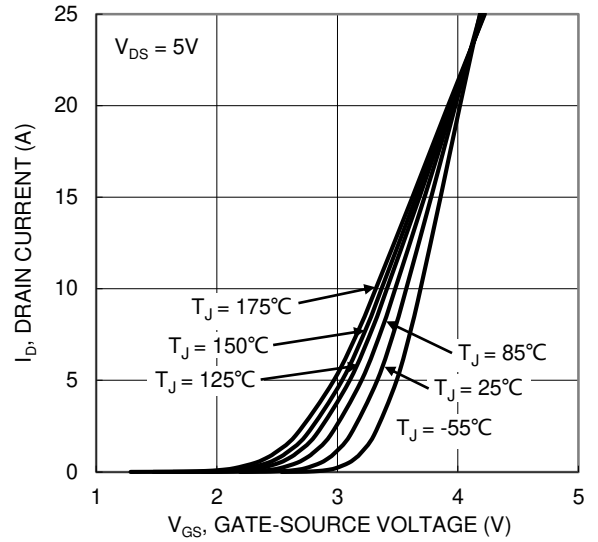


Figure 2. Typical Transfer Characteristic

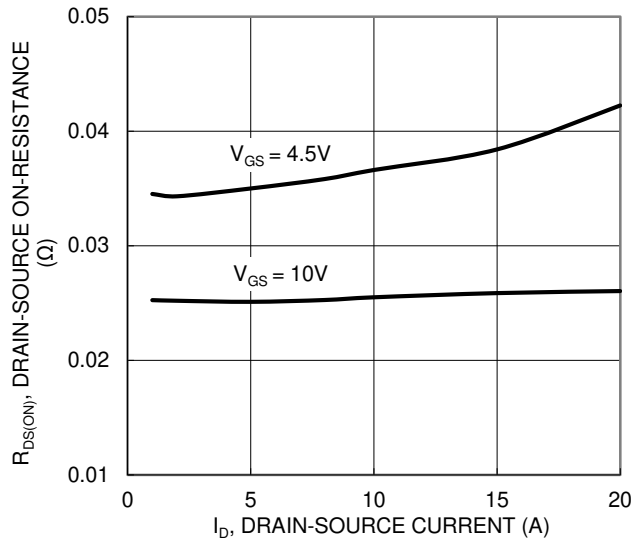


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

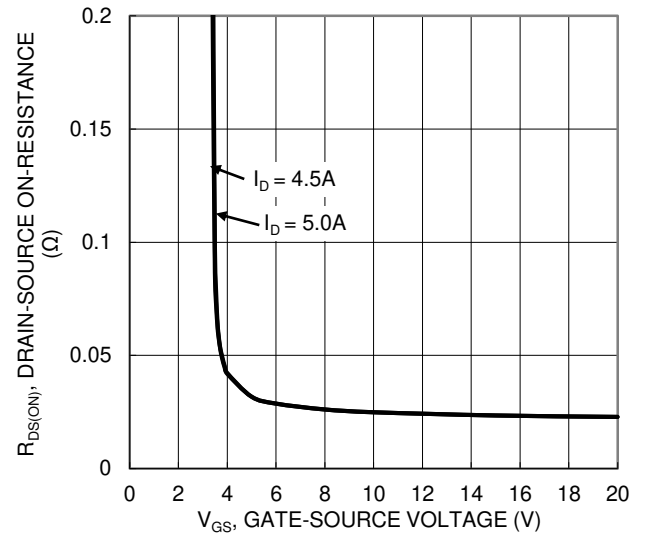


Figure 4. Typical Transfer Characteristic

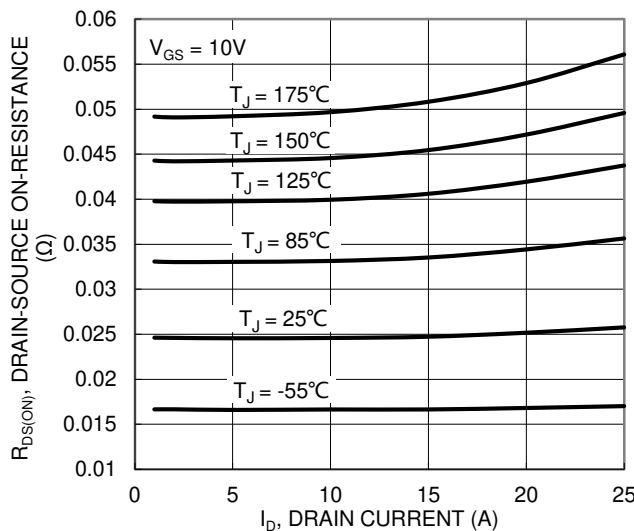


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

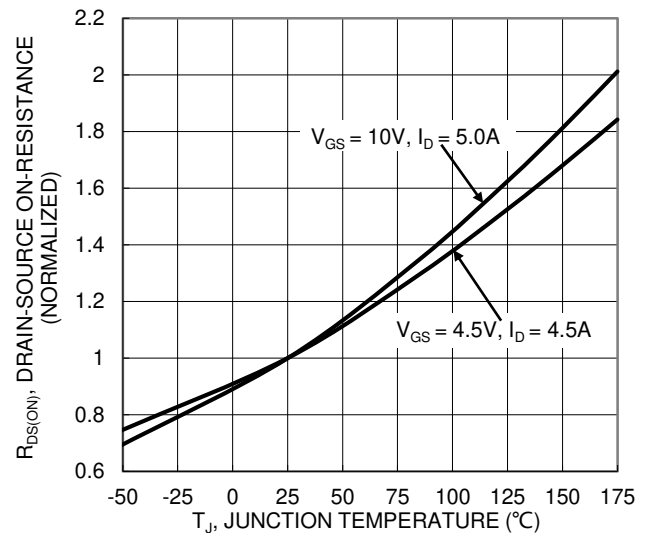


Figure 6. On-Resistance Variation with Temperature

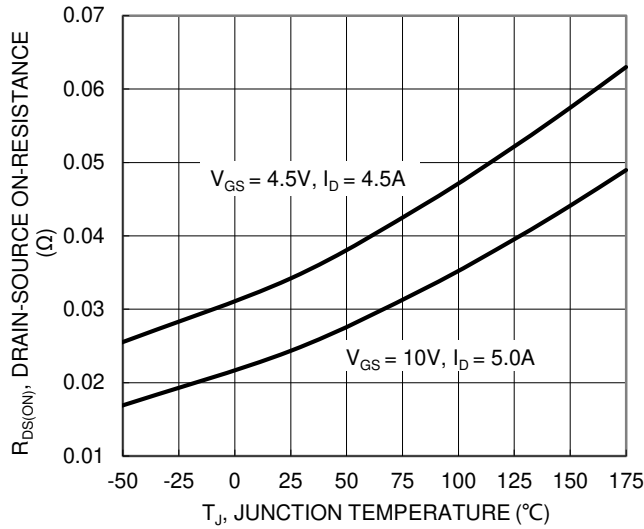


Figure 7. On-Resistance Variation with Temperature

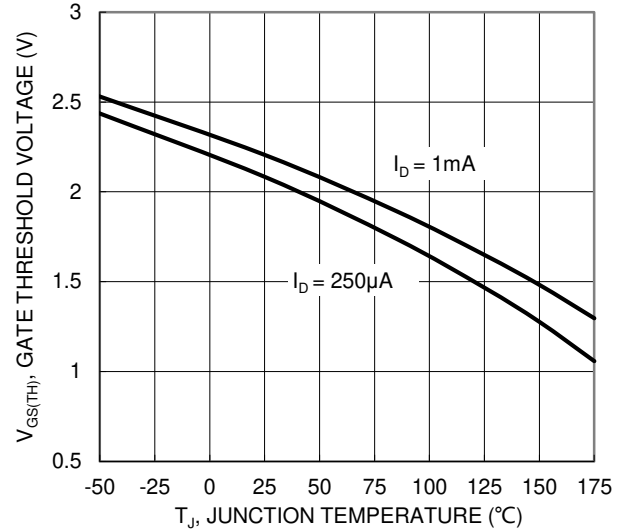


Figure 8. Gate Threshold Variation vs. Junction Temperature

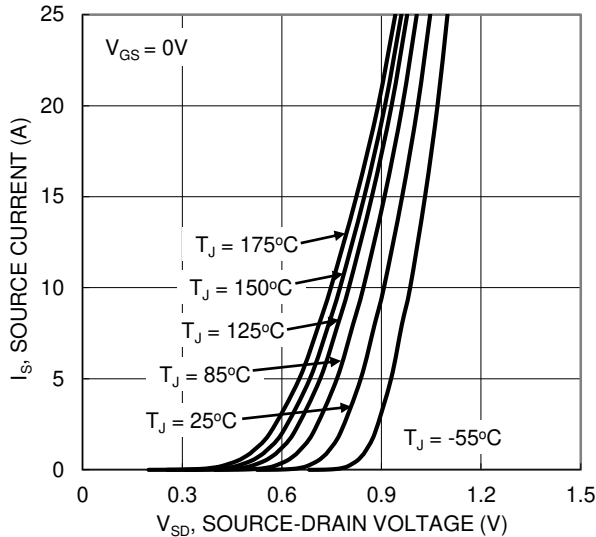


Figure 9. Diode Forward Voltage vs. Current

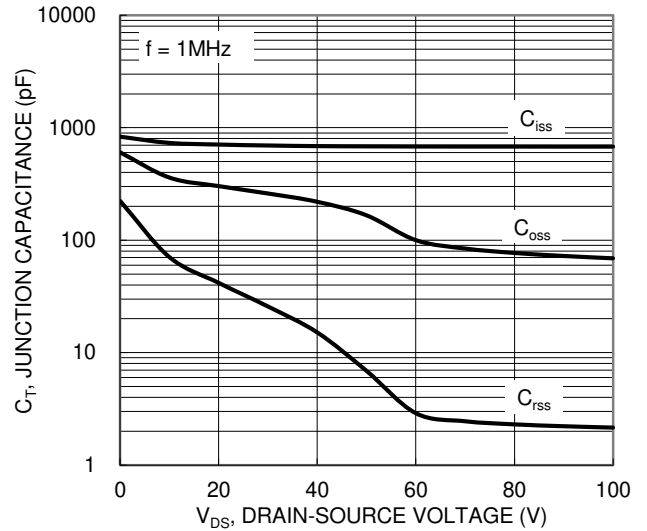


Figure 10. Typical Junction Capacitance

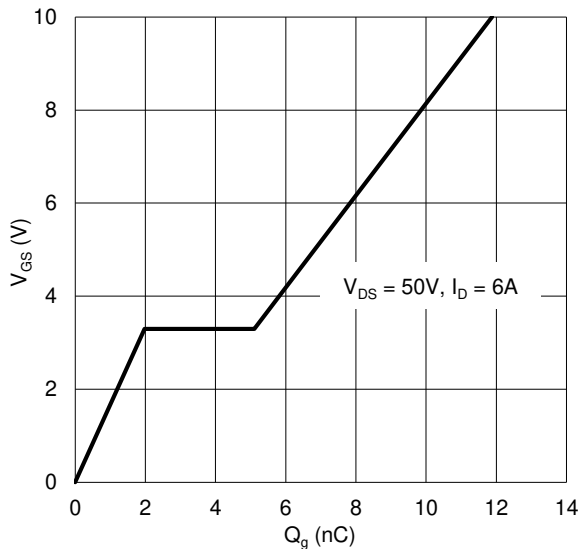


Figure 11. Gate Charge

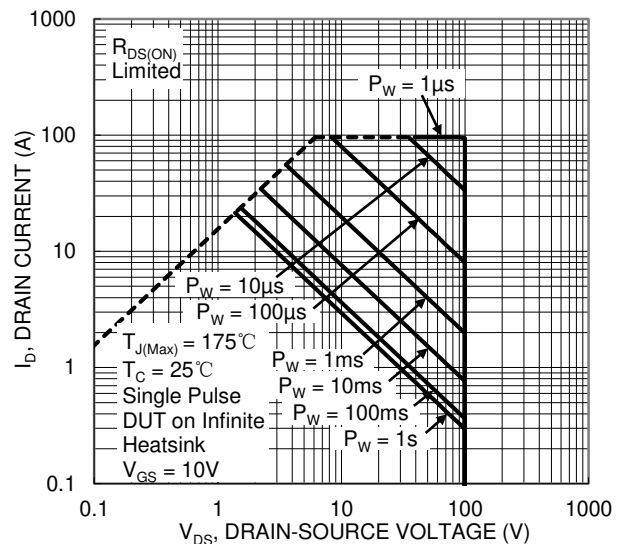


Figure 12. SOA, Safe Operation Area

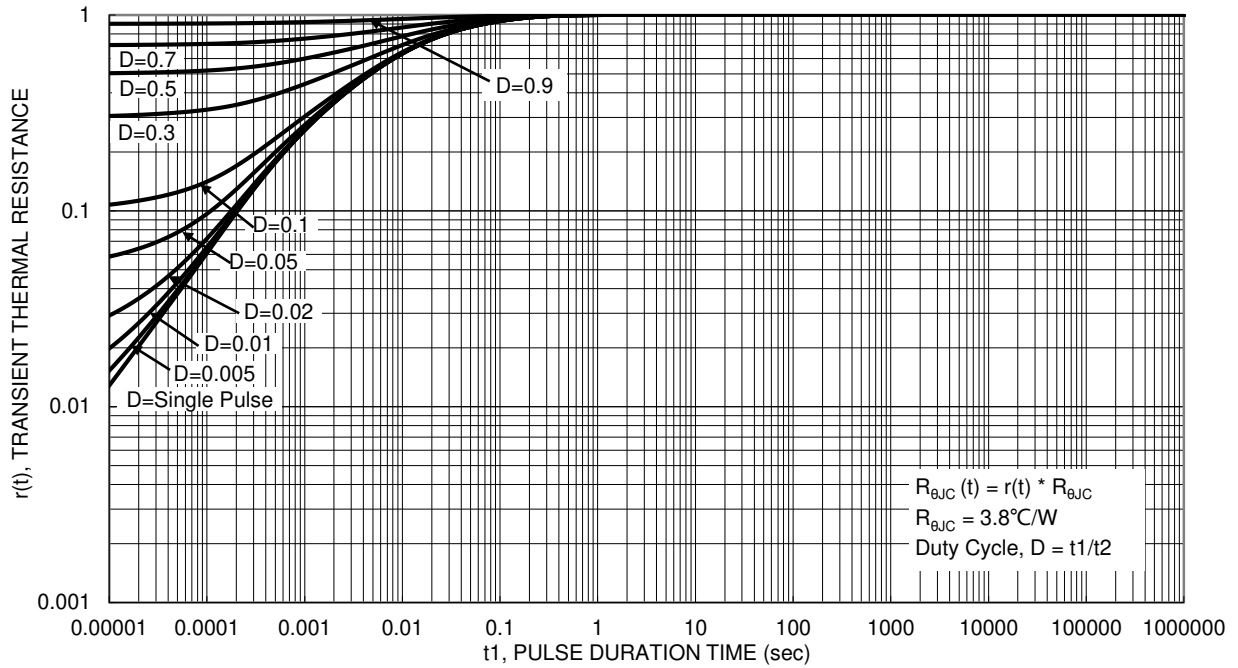
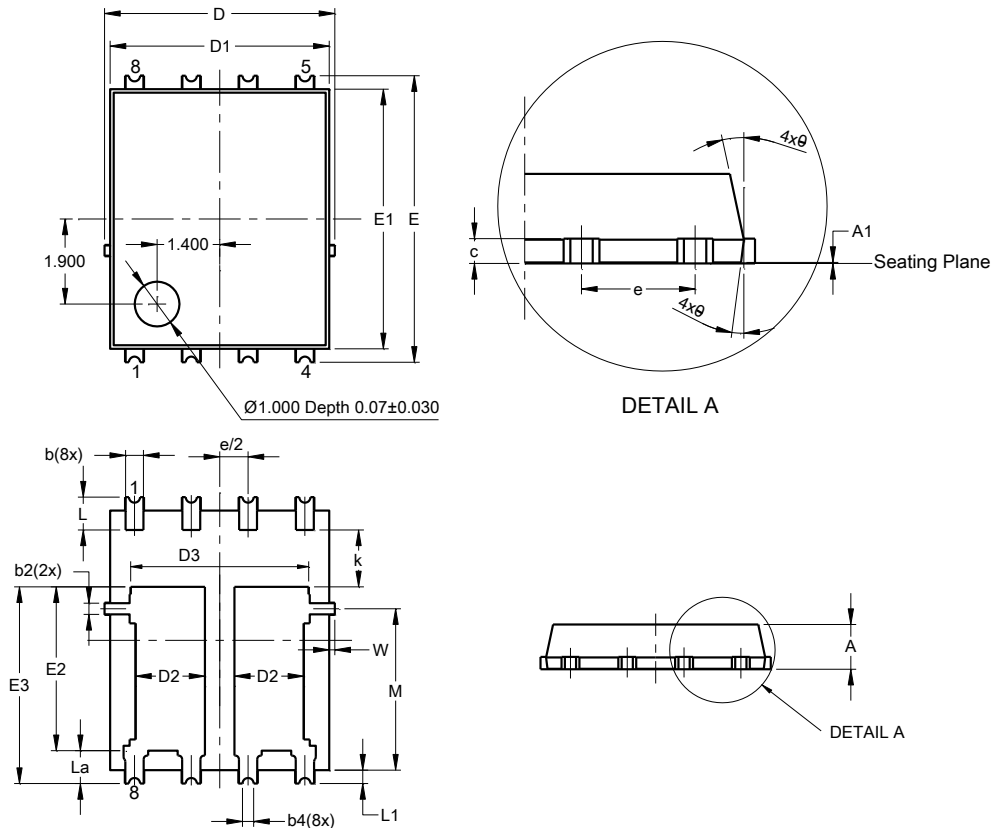


Figure 13. Transient Thermal Resistance

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI5060-8/SWP (Type UXD)**

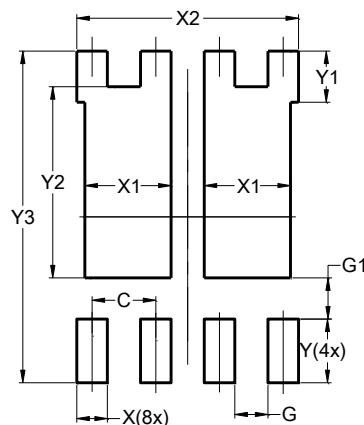


| PowerDI5060-8/SWP (Type UXD) |          |       |       |
|------------------------------|----------|-------|-------|
| Dim                          | Min      | Max   | Typ   |
| A                            | 0.90     | 1.10  | 1.00  |
| A1                           | 0.00     | 0.05  | --    |
| b                            | 0.30     | 0.50  | 0.41  |
| b2                           | 0.20     | 0.35  | 0.25  |
| b4                           | 0.25REF  |       |       |
| c                            | 0.230    | 0.330 | 0.277 |
| D                            | 5.15 BSC |       |       |
| D1                           | 4.70     | 5.10  | 4.90  |
| D2                           | 1.46     | 1.66  | 1.55  |
| D3                           | 3.78     | 4.18  | 3.98  |
| E                            | 6.40 BSC |       |       |
| E1                           | 5.60     | 6.00  | 5.80  |
| E2                           | 3.46     | 3.86  | 3.66  |
| E2a                          | 4.195    | 4.595 | 4.395 |
| e                            | 1.27BSC  |       |       |
| k                            | 1.05     | --    | --    |
| L                            | 0.635    | 0.835 | 0.735 |
| La                           | 0.635    | 0.835 | 0.735 |
| L1                           | 0.200    | 0.400 | 0.300 |
| M                            | 3.205    | 4.005 | 3.605 |
| W                            | 0.025    | 0.225 | 0.125 |
| θ                            | 10°      | 12°   | 11°   |
| θ1                           | 6°       | 8°    | 7°    |
| All Dimensions in mm         |          |       |       |

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI5060-8/SWP (Type UXD)**



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 1.270         |
| G          | 0.660         |
| G1         | 0.820         |
| X          | 0.610         |
| X1         | 1.720         |
| X2         | 4.420         |
| Y          | 1.270         |
| Y1         | 1.020         |
| Y2         | 3.810         |
| Y3         | 6.610         |

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